Floppy board 3.0

Rev: 3.0

2023-02-17

	Sourced	Placed	References	Value	Footprint	Quantity
1			C2, C3, C6, C8, C9	100nF	C_0805_2012Metric_Pad 1.18x1.45mm_HandSolde r	5
2			C4, C5	1uF	C_0805_2012Metric_Pad 1.18x1.45mm_HandSolde r	2
3			C1	4.7uF	C_0805_2012Metric_Pad 1.18x1.45mm_HandSolde r	1
4			С7	10uF	C_0805_2012Metric_Pad 1.18x1.45mm_HandSolde r	1
5			R2, R3, R6, R7	5.1k	R_0805_2012Metric_Pad 1.20x1.40mm_HandSolde r	4
6			R4, R5	1k	R_0805_2012Metric_Pad 1.20x1.40mm_HandSolde r	2
7			R1	10k	R_0805_2012Metric_Pad 1.20x1.40mm_HandSolde r	1
8			D1, D5	SD103AW	D_SOD-123	2
9			D2	USER_LED	LED_0805_2012Metric_P ad1.15x1.40mm_HandSol der	1
10			D3	SD103AW	D_SOD-123F	1
11			D4	3V3_POWER_LED	LED_0805_2012Metric_P ad1.15x1.40mm_HandSol der	1
12			U1	STM32G03xxxxx	TSSOP- 20_4.4x6.5mm_P0.65mm	1
13			U2	AT24C32	SOP- 8_3.9x4.9mm_P1.27mm	1
14			U3	H7233-1	SOT-23	1
15			U4	CH340N	SOP- 8_3.9x4.9mm_P1.27mm	1
16			F1	500mA	Fuse_1206_3216Metric_ Pad1.42x1.75mm_HandSo lder	1
17			SW1	RESET_B	SMD BUTTON 5.1x5.1	1
18			SW2	BOOTØ/U_BUTT	SMD BUTTON 5.1x5.1	1
19			JP1	SDA_JP	SolderJumper- 2_P1.3mm_Open_Rounded Pad1.0x1.5mm	1
20			JP2	SCL_JP	SolderJumper- 2_P1.3mm_Open_Rounded Pad1.0x1.5mm	1
21			JP3	WP_JP	SolderJumper- 2_P1.3mm_Open_Rounded Pad1.0x1.5mm	1
22			Ј2	USB-C_304A-ACP16X	USB_C_304A-ACP16X	1
23			J4	I/0 DX	PinHeader_1x12_P2.54m m_Vertical	1



